## RC5532/RC5532A

## High Performance Dual Low Noise Operational Amplifier

## Features

- Small signal bandwidth -10 MHz
- Output drive capability $-600 \Omega, 10$ VRMS
- Input noise voltage $-5 \mathrm{nV} / \sqrt{\mathrm{Hz}}$
- DC voltage gain - 50,000
- AC voltage gain - 2200 at 10 KHz
- Power bandwidth -140 KHz
- Slew rate - $8 \mathrm{~V} / \mu \mathrm{S}$
- Large supply voltage range $- \pm 3 \mathrm{~V}$ to $\pm 20 \mathrm{~V}$


## Description

The RC5532 is a high performance, dual low noise operational amplifier. Compared to standard dual operational amplifiers, such as the RC747, it shows better noise performance, improved output drive capability, and considerably higher small-signal and power bandwidths.

This makes the device especially suitable for application in high quality and professional audio equipment, instrumentation, control circuits, and telephone channel amplifiers. The op amp is internally compensated for gains equal to one. If very low noise is of prime importance, it is recommended that the RC5532A version be used which has guaranteed noise specifications.

## Block Diagram



## Pin Assignments



## Absolute Maximum Ratings

(beyond which the device may be damaged) ${ }^{1}$

| Parameter |  | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply Voltage |  |  |  | $\pm 22$ | V |
| Input Voltage |  |  |  | $\pm$ VS | V |
| Differential Input Voltage |  |  |  | 0.5 | V |
| PDTA $<50^{\circ} \mathrm{C}$ | PDIP |  |  | 468 | mW |
|  | CerDIP |  |  | 833 |  |
|  | SOIC |  |  | 658 |  |
| Junction Temperature | PDIP |  |  | 125 | ${ }^{\circ} \mathrm{C}$ |
|  | CerDIP, TO-99 |  |  | 175 |  |
| Storage Temperature |  | -65 |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| Operating Temperature | RM5532/A | -55 |  | 125 | ${ }^{\circ} \mathrm{C}$ |
|  | RC5532/A | 0 |  | 70 |  |
| Lead Soldering Temperature (10 sec) |  |  |  | 300 | ${ }^{\circ} \mathrm{C}$ |

## Notes:

1. Functional operation under any of these conditions is NOT implied.
2. For supply voltages less than $\pm 15 \mathrm{~V}$, the absolute maximum input voltage is equal to the supply voltage.
3. Short circuit to ground on one amplifier only.

## Operating Conditions

| Parameter |  |  | Min. | Typ. | Max. | $\begin{aligned} & \text { Units } \\ & \hline{ }^{\circ} \mathrm{C} / \mathrm{W} \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ӨJc | Thermal resistance | CerDIP |  | 45 |  |  |
|  |  | TO-99 |  | 50 |  |  |
| ӨJA | Thermal resistance | PDIP |  | 160 |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  | CerDIP |  | 150 |  |  |
|  |  | TO-99 |  | 190 |  |  |
| For $\mathrm{T}_{\mathrm{A}}>50^{\circ} \mathrm{C}$ Derate at |  | PDIP |  | 6.25 |  | $\mathrm{mW} /{ }^{\circ} \mathrm{C}$ |
|  |  | CerDIP |  | 8.33 |  |  |
|  |  | TO-99 |  | 5.26 |  |  |

## DC Electrical Characteristics

$\left(\mathrm{V} S= \pm 15 \mathrm{~V}\right.$ and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ unless otherwise noted)

| Parameters | Test Conditions | RM5532/5532A |  |  | RC5532/5532A |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |
| Input Offset Voltage |  |  | 0.5 | 2.0 |  | 0.5 | 4.0 | mV |
|  | Over Temperature |  |  | 3.0 |  |  | 5.0 | mV |
| Input Offset Current |  |  |  | 100 |  | 10 | 150 | nA |
|  | Over Temperature |  |  | 200 |  |  | 200 | nA |
| Input Bias Current |  |  | 200 | 400 |  | 200 | 800 | nA |
|  | Over Temperature |  |  | 700 |  |  | 1000 | nA |
| Supply Current |  |  | 6.0 | 11 |  | 6.0 | 16 | mA |
|  | Over Temperature |  |  | 13 |  |  | 22 | mA |
| Input Voltage Range |  | $\pm 12$ | $\pm 13$ |  | $\pm 12$ | $\pm 13$ |  | V |
| Common Mode Rejection Ratio |  | 80 | 100 |  | 70 | 100 |  | dB |
| Power Supply Rejection Ratio |  | 86 | 100 |  | 80 | 100 |  | dB |
| Large Signal Voltage Gain | $\mathrm{RL} \geq 2 \mathrm{~K} \Omega$, VOUT $= \pm 10 \mathrm{~V}$ | 50 |  |  | 25 | 100 |  | V/mV |
|  | Over Temperature | 25 |  |  | 15 | 50 |  |  |
|  | $\mathrm{RLL}^{2} 600 \Omega$, VOUT $= \pm 10 \mathrm{~V}$ | 40 |  |  | 15 | 50 |  |  |
|  | Over Temperature | 20 |  |  | 10 |  |  |  |
| Output Voltage Swing | $R \mathrm{~L} \geq 600 \Omega$ | $\pm 12$ | $\pm 13$ |  | $\pm 12$ | $\pm 13$ |  | V |
|  | $\mathrm{RL}_{\mathrm{L}}=600 \Omega, \mathrm{~V}$ S $= \pm 18 \mathrm{~V}$ | $\pm 15$ | $\pm 16$ |  | $\pm 15$ | $\pm 16$ |  |  |
|  | $\mathrm{RL} \geq 2 \mathrm{k} \Omega$ | $\pm 12$ | $\pm 13$ |  |  |  |  |  |
| Input Resistance (Diff. Mode) |  |  | 300 |  |  | 300 |  | $\mathrm{K} \Omega$ |
| Short Circuit Current |  |  | 38 |  |  | 38 |  | mA |

## Notes:

1. Diodes protect the inputs against over-voltage. Therefore, unless current-limiting resistors are used, large currents will flow if the differential input voltage exceeds 0.6 V . Maximum input current should be limited to $\pm 10 \mathrm{~mA}$.
2. Over Temperature: $\mathrm{RM}=55^{\circ} \mathrm{C} \leq \mathrm{TA}_{\mathrm{A}} \leq 125^{\circ} \mathrm{C} ; \mathrm{RC}=0^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 70^{\circ} \mathrm{C}$

## Electrical Characteristics

$\left(\mathrm{VS}= \pm 15 \mathrm{~V}\right.$ and $\mathrm{TA}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ )

| Parameters | Test Conditions | RC/RM5532 |  |  | RC/RM5532A |  |  | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |
| Input Noise Voltage Density | $\mathrm{FO}=30 \mathrm{~Hz}$ |  | 8.0 |  |  | 8.0 | 12 | $\begin{aligned} & \mathrm{nV/} \\ & \sqrt{\mathrm{~Hz}} \end{aligned}$ |
|  | $\mathrm{FO}=1 \mathrm{kHz}$ |  | 5.0 |  |  | 5.0 | 6.0 |  |
| Input Noise Current Density | $\mathrm{FO}=30 \mathrm{~Hz}$ |  | 2.7 |  |  | 2.7 |  | $\frac{\mathrm{pA} /}{\sqrt{\mathrm{Hz}}}$ |
|  | $\mathrm{FO}=1 \mathrm{kHz}$ |  | 0.7 |  |  | 0.7 |  |  |
| Channel Separation | $\mathrm{F}=1 \mathrm{kHz}, \mathrm{RS}=5 \mathrm{k} \Omega$ |  | 110 |  |  | 110 |  | dB |

## AC Electrical Characteristics

( $\mathrm{V}_{\mathrm{S}}= \pm 15 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ )

| Parameters | Test Conditions | Min. | Typ. | Max. | Units |
| :--- | :--- | :---: | :---: | :---: | :---: |
| Output Resistance | $\mathrm{AV}=30 \mathrm{~dB}$ Closed Loop, $\mathrm{F}=10 \mathrm{kHz}$, <br> $\mathrm{RL}=600 \Omega$ |  | 0.3 |  | $\Omega$ |
| Overshoot | Unity Gain, VIN $=100 \mathrm{mVp}-\mathrm{p}$ <br> $\mathrm{CL}=100 \mathrm{pF}, \mathrm{RL}=600 \Omega$ |  | 10 |  | $\%$ |
| Gain | $\mathrm{F}=10 \mathrm{KHz}$ |  | 2.2 |  | $\mathrm{~V} / \mathrm{mV}$ |
| Gain Bandwidth Product | $\mathrm{CL}=100 \mathrm{pF}, \mathrm{RL}=600 \Omega$ |  | 10 |  | MHz |
| Slew Rate |  | 8.0 | $\mathrm{~V} / \mu \mathrm{S}$ |  |  |
| Power Bandwidth | VOUT $= \pm 10 \mathrm{~V}$ |  | 140 | KHz |  |
|  | VOUT $= \pm 14 \mathrm{~V}, \mathrm{RL}_{\mathrm{L}}=600 \Omega, \mathrm{VS}= \pm 18 \mathrm{~V}$ |  | 100 | KHz |  |

## Test Circuits



Figure 1. Closed Loop Frequency Response


Figure 2. Follower, Transient Response

## Typical Performance Characteristics



Figure 3. Open Loop Gain vs. Frequency


Figure 5. Output Voltage Swing vs. Frequency


Figure 7. Supply Current vs. Supply Voltage


Figure 4. Closed Loop Gain vs. Frequency


Figure 6. Short Circuit Current vs. Temperature


Figure 8. Input Bias Current vs. Temperature

Typical Performance Characteristics (continued)


Figure 9. Output Voltage Swing vs. Supply Voltage


Figure 10. Common Mode Input Range vs. Supply Voltage


Figure 11. Follower Large Signal Pulse Response


Figure 12. Transient Response Output Voltage vs. Time


Figure 13. Input Noise Density vs. Frequency

## Notes:

## Notes:

## Mechanical Dimensions

## 8-Lead Ceramic DIP Package

| Symbol | Inches |  | Millimeters |  | Notes |
| :--- | :---: | :---: | :---: | :---: | :---: |
|  | Min. | Max. | Min. | Max. |  |
| A | - | .200 | - | 5.08 |  |
| b 1 | .014 | .023 | .36 | .58 | 8 |
| b 2 | .045 | .065 | 1.14 | 1.65 | 2,8 |
| c 1 | .008 | .015 | .20 | .38 | 8 |
| D | - | .405 | - | 10.29 | 4 |
| E | .220 | .310 | 5.59 | 7.87 | 4 |
| e | .100 BSC |  | 2.54 BSC | 5,9 |  |
| eA | .300 BSC |  | 7.62 BSC | 7 |  |
| L | .125 | .200 | 3.18 | 5.08 |  |
| Q | .015 | .060 | .38 | 1.52 | 3 |
| s 1 | .005 | - | .13 | - | 6 |
| $\alpha$ | $90^{\circ}$ | $105^{\circ}$ | $90^{\circ}$ | $105^{\circ}$ |  |

## Notes:

1. Index area: a notch or a pin one identification mark shall be located adjacent to pin one. The manufacturer's identification shall not be used as pin one identification mark.
2. The minimum limit for dimension "b2" may be .023 ( .58 mm ) for leads number $1,4,5$ and 8 only.
3. Dimension " Q " shall be measured from the seating plane to the base plane.
4. This dimension allows for off-center lid, meniscus and glass overrun.
5. The basic pin spacing is $.100(2.54 \mathrm{~mm})$ between centerlines. Each pin centerline shall be located within $\pm .010(.25 \mathrm{~mm})$ of its exact longitudinal position relative to pins 1 and 8.
6. Applies to all four corners (leads number $1,4,5$, and 8 ).
7. "eA" shall be measured at the center of the lead bends or at the centerline of the leads when " $\alpha$ " is $90^{\circ}$.
8. All leads - Increase maximum limit by $.003(.08 \mathrm{~mm})$ measured at the center of the flat, when lead finish applied.
9. Six spaces.


Mechanical Dimensions (continued)

## 8-Lead Plastic DIP Package

| Symbol | Inches |  | Millimeters |  | Notes |
| :--- | :---: | :---: | :---: | :---: | :---: |
|  | Min. | Max. | Min. | Max. |  |
| A | - | .210 | - | 5.33 |  |
| A1 | .015 | - | .38 | - |  |
| A2 | .115 | .195 | 2.93 | 4.95 |  |
| B | .014 | .022 | .36 | .56 |  |
| B1 | .045 | .070 | 1.14 | 1.78 |  |
| C | .008 | .015 | .20 | .38 | 4 |
| D | .348 | .430 | 8.84 | 10.92 | 2 |
| D1 | .005 | - | .13 | - |  |
| E | .300 | .325 | 7.62 | 8.26 |  |
| E1 | .240 | .280 | 6.10 | 7.11 | 2 |
| e | .100 | BSC | 2.54 BSC |  |  |
| eB | - | .430 | - | 10.92 |  |
| L | .115 | .160 | 2.92 | 4.06 |  |
| N | $8^{\circ}$ |  |  | $8^{\circ}$ |  |

## Notes:

1. Dimensioning and tolerancing per ANSI Y14.5M-1982.
2. "D" and "E1" do not include mold flashing. Mold flash or protrusions shall not exceed .010 inch ( 0.25 mm ).
3. Terminal numbers are for reference only.
4. "C" dimension does not include solder finish thickness.
5. Symbol " N " is the maximum number of terminals.


Mechanical Dimensions (continued)

## 8-Lead Metal Can IC Header Package



| Symbol | Inches |  | Millimeters |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min. | Max. | Min. | Max. |  |
| A | . 165 | . 185 | 4.19 | 4.70 |  |
| øb | . 016 | . 019 | . 41 | . 48 | 1,5 |
| øb1 | . 016 | . 021 | . 41 | . 53 | 1,5 |
| $\emptyset \mathrm{D}$ | . 335 | . 375 | 8.51 | 9.52 |  |
| øD1 | . 305 | . 335 | 7.75 | 8.51 |  |
| øD2 | . 110 | . 160 | 2.79 | 4.06 |  |
| e | . 200 BSC |  | 5.08 BSC |  |  |
| e1 | . 100 BSC |  | 2.54 BSC |  |  |
| F | - | . 040 | - | 1.02 |  |
| k | . 027 | . 034 | . 69 | . 86 |  |
| k1 | . 027 | . 045 | . 69 | 1.14 | 2 |
| L | . 500 | . 750 | 12.70 | 19.05 | 1 |
| L1 | - | . 050 | - | 1.27 | 1 |
| L2 | . 250 | - | 6.35 | - | 1 |
| Q | . 010 | . 045 | . 25 | 1.14 |  |
| $\alpha$ | $45^{\circ} \mathrm{BSC}$ |  | $45^{\circ} \mathrm{BSC}$ |  |  |

## Notes:

1. (All leads) øb applies between L1 \& L2. øb1 applies between L2 \& . 500 ( 12.70 mm ) from the reference plane. Diameter is uncontrolled in L1 \& beyond . 500 ( 12.70 mm ) from the reference plane.
2. Measured from the maximum diameter of the product.
3. Leads having a maximum diameter .019 (.48mm) measured in gauging plane, $.054(1.37 \mathrm{~mm})+.001(.03 \mathrm{~mm})-.000(.00 \mathrm{~mm})$ below the reference plane of the product shall be within $.007(.18 \mathrm{~mm})$ of their true position relative to a maximum width tab.
4. The product may be measured by direct methods or by gauge.
5. All leads - increase maximum limit by .003 (.08mm) when lead finish is applied.

## Ordering Information

| Product Number | Temperature Range | Screening | Package |
| :--- | :---: | :---: | :---: |
| RC5532D/RC5532AD | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Commercial | 8 Pin Ceramic DIP |
| RC5532N/RC5532AN | $0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$ | Commercial | 8 Pin Plastic DIP |
| RM5532D/RM5532AD | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Commercial | 8 Pin Ceramic DIP |
| RM5532D/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Military | 8 Pin Ceramic DIP |
| RM5532AD/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Military | 8 Pin Ceramic DIP |
| RM5532T/RM5532AT | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Commercial | 8 Pin TO-99 Metal Can |
| RM5532T/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Military | 8 Pin TO- 99 Metal Can |
| RM5532AT/883B | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | Military | 8 Pin TO-99 Metal Can |

## Note:

1. /883B suffix denotes MIL-STD-883, Par. 1.2.1 compliant device.

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